## **Amendments to the Claims:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

## **Listing of Claims:**

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#### Claims 1-3. (cancelled)

- 4. (currently amended) A digital film grain as in claim 4 <u>17</u> wherein said photodetector is direct radiation detector.
- 5. (currently amended) A digital film grain as in claim 4 wherein <u>said direct radiation detector is comprised of</u> a layer selected from a group comprised of cadmium telluride, cadmium zinc telluride, lead iodide, mercuric iodide, and amorphous selenium is said direct radiation detector.
- 6. (currently amended) A digital film grain as in claim 4 <u>17</u> wherein said photodetector is an indirect radiation detector.
- 7. (currently amended) A digital film grain as in claim 4 17 wherein a luminophor is in proximity to said photodetector.
- 8. (currently amended) A digital film grain as in claim 4 <u>17</u> wherein said transponder comprises a radio frequency generator.
- 9. (currently amended) A digital film grain as in claim + <u>17</u> wherein said transponder comprises an antenna.
- 10. (currently amended) A digital film grain as in claim + <u>17</u> wherein said transponder comprises a modulator.
- 11. (currently amended) A digital film grain as in claim 4 <u>17</u> wherein said transponder extracts electrical energy from a radiated field to provide electrical power for said digital film grain.

12. (currently amended) A digital film grain as in claim  $\pm \frac{17}{12}$  wherein electrical power for said photodetector and said transponder is stored in a capacitor.

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- 13. (original) A digital film grain as in claim 12 wherein said capacitor is located on said digital film grain.
- 14. (currently amended) A digital film grain as in claim 4 <u>17</u> wherein a layer of x-ray converting material is in optical contact with a photodetective surface of said digital film grain.
- 15. (original) A digital film grain as in claim 14 wherein said digital film grain is disposed in a container.
- 16. (original) A digital film grain as in claim 15 wherein said container is a capillary.
- 17. (currently amended) A digital film grain as in claim 1 for detection of x-rays which comprises:

a photodetector which produces an electrical signal having a strength which is related to an input x-ray flux;

a transponder which receives said electrical signal and transmits information quantifying said electrical signal; and

wherein said digital film grain is disposed in a container and said container contains a material producing a light emission in response to an input radiation flux.

- 18. (currently amended) A digital film grain as in claim + 17 wherein said digital film grain has an individual identifier.
- 19. (currently amended) A digital film grain as in claim  $\pm 17$  wherein said photodetector is selected from a group comprised of photodiode,

charged coupled device (CCD), complementary metal oxide semiconductor (CMOS), phototransistor, and avalanche photodiode.

#### 20. (cancelled)

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21. (currently amended) An imaging system comprising:

a distribution of two or more digital film grains wherein

each of said digital film grains comprise a photodetector and transponder;

a base station containing a transponder capable of sending information to and receiving information from to <u>each of</u> said digital film <del>grains</del> grain transponder; and

an image accumulator which assembles signals related to an light flux received at said digital film grains and arranging said signals in an order dependent upon a location of each of said digital grains.

## Claims 22-24. (cancelled)

25. (original) A method of acquiring an image by:

detecting an irradiance profile with a distribution of digital film grains;

sending a signal and an identification number from each of said digital film grains to an image accumulator;

determining a location of each of said digital film grains in said distribution;

assembling said signals from said digital film grains in an order according to said location of each of said digital film grain.

26. (original) A method for determining locations of digital film grains in a distribution by:

directing a spot of irradiation to which said distribution is sensitive toward said distribution, wherein at least one dimension of said spot of irradiation is smaller than a smallest distance between said digital film grains; recording said location of each of said spots of irradiation; recording signals from said digital film grains in said
distribution; and
correlating said location of said spot of irradiation to each
of said digital film grains sending a signal exceeding a predetermined threshold.

27. (original) A method as in claim 26 comprising:

moving said spot of irradiation to another location and correlating digital film grain signals with location until a set of locations for a substantial fraction of the film grains in said distribution have sent a signal indicating detection of irradiation.

### 28. (cancelled)

Claims 29-33. (cancelled)

34. (currently amended) A digital film grain as in claim 33 for detection of visible light, ultraviolet, or infrared radiation which comprises:

a photodetector which produces an electrical signal having a strength which is related to an input radiation;

<u>a transponder which receives said electrical signal and</u> <u>transmits information quantifying said electrical signal;</u>

wherein components of said digital film grain are fabricated on a single substrate; and

wherein spatial dimensions in said substrate are approximately equal with a pixel size of an image produced by an array of said digital film grains.

35. (currently amended) A digital film grain of claim 33 for detection of visible light, ultraviolet, or infrared radiation which comprises:

a photodetector which produces an electrical signal having a strength which is related to an input radiation;

a transponder which receives said electrical signal and transmits information quantifying said electrical signal;

# wherein components of said digital film grain are fabricated

## on a single substrate; and

smaller.

wherein said substrate spatial dimension is 200 μm or